

SGM8418-1/SGM8418-2/SGM8418-4 24V, 3A Peak Output Current Rail-to-Rail I/O Operational Amplifiers

GENERAL DESCRIPTION

The SGM8418-1(single), SGM8418-2 (dual) and SGM8418-4 (quad) are high slew rate, low power operational amplifiers optimized for high voltage systems. These devices can operate on single or dual power supply. They support rail-to-rail input and output operation.

The SGM8418-1/2/4 feature 10mV maximum offset voltage, 3A peak output current, and 65V/µs high slew rate. The combination of characteristics makes them suitable for TFT-LCDs.

The SGM8418-1 is available in a Green TDFN-3×3-8L package. The SGM8418-2 is available in a Green MSOP-8 (Exposed Pad) package. The SGM8418-4 is available in a Green TSSOP-14 (Exposed Pad) package. They are specified over the -40°C to +85°C temperature range.

FEATURES

- Peak Output Current: 3A
- High Slew Rate: 65V/µs
- Unity-Gain Stable
- Rail-to-Rail Input and Output
- Supply Voltage Range: 4.5V to 26.5V
- -40°C to +85°C Operating Temperature Range
- Small Packaging: SGM8418-1 Available in a Green TDFN-3×3-8L Package SGM8418-2 Available in a Green MSOP-8 (Exposed Pad) Package SGM8418-4 Available in a Green TSSOP-14 (Exposed Pad) Package

APPLICATIONS

TFT-LCD Panels LCD TVs Monitors Laptops

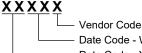


PACKAGE/ORDERING INFORMATION

MODEL	PACKAGE DESCRIPTION	SPECIFIED TEMPERATURE RANGE	ORDERING NUMBER	PACKAGE MARKING	PACKING OPTION
SGM8418-1	TDFN-3×3-8L	-40°C to +85°C	SGM8418-1YTDB8G/TR	SGM G41DB XXXXX	Tape and Reel, 4000
SGM8418-2	MSOP-8 (Exposed Pad)	-40°C to +85°C	SGM8418-2YPMS8G/TR	SGM84182 YPMS8 XXXXX	Tape and Reel, 4000
SGM8418-4	TSSOP-14 (Exposed Pad)	-40°C to +85°C	SGM8418-4YPTS14G/TR	SGM84184 YPTS14 XXXXX	Tape and Reel, 4000

MARKING INFORMATION

NOTE: XXXXX = Date Code and Vendor Code.



Date Code - Week - Date Code - Year

Green (RoHS & HSF): SG Micro Corp defines "Green" to mean Pb-Free (RoHS compatible) and free of halogen substances. If you have additional comments or questions, please contact your SGMICRO representative directly.

ABSOLUTE MAXIMUM RATINGS

Supply Voltage, +V _S to -V _S	0.3V to 28V
Input/Output Voltage to -Vs	0.3V to (+V _S) + 0.3V
+IN to -IN	±5V
Package Thermal Resistance	
TDFN-3×3-8L, θ _{JA}	
MSOP-8 (Exposed Pad), θ _{JA}	
TSSOP-14 (Exposed Pad), θ _{JA}	50°C/W
Junction Temperature	+150°C
Storage Temperature Range	65°C to +150°C
Lead Temperature (Soldering, 10s)	+260°C
ESD Susceptibility	
HBM	8000V
MM	
CDM	1000V

RECOMMENDED OPERATING CONDITIONS

Supply Voltage Range	4.5V to 26.5V
Operating Temperature Range	40°C to +85°C

OVERSTRESS CAUTION

Stresses beyond those listed in Absolute Maximum Ratings may cause permanent damage to the device. Exposure to absolute maximum rating conditions for extended periods may affect reliability. Functional operation of the device at any conditions beyond those indicated in the Recommended Operating Conditions section is not implied.

ESD SENSITIVITY CAUTION

This integrated circuit can be damaged if ESD protections are not considered carefully. SGMICRO recommends that all integrated circuits be handled with appropriate precautions. Failure to observe proper handling and installation procedures can cause damage. ESD damage can range from subtle performance degradation to complete device failure. Precision integrated circuits may be more susceptible to damage because even small parametric changes could cause the device not to meet the published specifications.

DISCLAIMER

SG Micro Corp reserves the right to make any change in circuit design, or specifications without prior notice.



FUNCTIONAL BLOCK DIAGRAMS

SGM8418-1 (TOP VIEW) SGM8418-1 7 NC 8 NC 1 2 7 -IN O-6 ____○ OUT +Vs -IN 2 3 -Vs +IN 아 + 6 OUT +IN 3 -Vs o -Vs 5 NC 4 TDFN-3×3-8L SGM8418-2 (TOP VIEW) SGM8418-2 OUTA O +Vs OUTA 8 1 o +Vs 2 7 -INA 아 о оитв 7 OUTB -INA 2 3 -Vs +INA o 6 -0 -INB +INA 3 6 -INB -Vs o 4 5 +INB -Vs **MSOP-8 (Exposed Pad)** SGM8418-4 (TOP VIEW) SGM8418-4 14 Ουτα OUTD 1 14 -0 **OUTD** OUTA c 13 • -IND -INA 2 -IND 13 2 -INA 아 12 • +IND 3 +INA +IND 3 12 +INA c <u>11</u> o -Vs +Vs 11 4 -Vs +Vso -Vs 10 5 +INB +INC 5 10 • **+INC** +INB o 6 9 o -INC -INB o -INB -INC 6 9

PIN CONFIGURATIONS

NOTE: For all packages, connect thermal die pad to -V_S. Connect it to -V_S plane to maximize thermal performance.

OUTC

8

7

OUTB -



OUTB

7

TSSOP-14 (Exposed Pad)

8

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ELECTRICAL CHARACTERISTICS

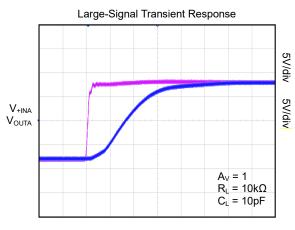
 $(+V_S = 16V, -V_S = 0V, +V_{IN} = V_{OUT} = +V_S/2$, typical values are at T_A = +25°C, unless otherwise specified.)

PARAMETER	SYMBOL	CONDITIONS	MIN	TYP	MAX	UNITS	
Input Characteristics		•	•		•		
Input Offset Voltage	Vos	$V_{CM} = +V_S/2$		2	10	mV	
Input Offset Voltage Drift	$\Delta V_{OS} / \Delta T$	$V_{CM} = +V_S/2$		3.6		µV/°C	
Input Bias Current	I _B	$V_{CM} = +V_S/2$		1		nA	
Land Damidation	A) (I _{OUT} = 0mA to -80mA		0.01			
Load Regulation	ΔV_{LOAD}	I _{OUT} = 0mA to 80mA		-0.01		mV/mA	
Input Common Mode Voltage Range	V _{CM}		-0.1		(+V _S) + 0.1	V	
Common Mode Rejection Ratio	CMRR	$-0.1V \le V_{CM} \le (+V_S) + 0.1V$		72		dB	
Open-Loop Voltage Gain	A _{OL}	$0.5V \le V_{OUT} \le (+V_S) - 0.5V$		120		dB	
Output Characteristics		•				•	
Low Output Voltage Swing from Rail	V _{OL}	I _L = -50mA		0.07	0.115	V	
High Output Voltage Swing from Rail	V _{OH}	I _L = 50mA	(+V _s) - 0.155	(+V _S) - 0.11		V	
Transient Peak Output Current	I _{PK}			±3		А	
Continuous Output Current	I _{OUT}			±400		mA	
Power Supply		•			•	•	
Supply Voltage Range			4.5		26.5	V	
Power Supply Rejection Ratio	PSRR	$+V_{\rm S}$ = 4.5V to 26.5V, $V_{\rm CM}$ = 3V		94		dB	
Quiescent Current/Amplifier	Ι _Q	No load		4.8		mA	
Dynamic Performance		•				•	
Slew Rate	SR			65		V/µs	
Settling Time to ±0.1%	ts	$A_V = 1$, $V_{OUT} = 2V$ step, $R_L = 10k\Omega$, $C_L = 10pF$		140		ns	
-3dB Bandwidth	BW	$R_L = 10k\Omega$, $C_L = 10pF$		75		MHz	
Gain-Bandwidth Product	GBP	$R_L = 10k\Omega$, $C_L = 10pF$		28		MHz	
Phase Margin		$R_L = 10k\Omega$, $C_L = 10pF$		33		0	
Noise Performance							
Input Voltage Noise Density	en	f = 1kHz		115		nV/√Hz	
Thermal Protection							
Thermal Shutdown Temperature	T _{SHDN}			150		°C	
Thermal Shutdown Hysteresis	ΔT_{SHDN}			25		°C	

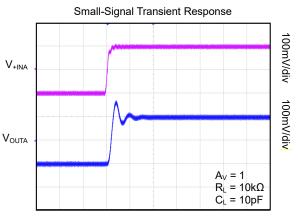


TYPICAL PERFORMANCE CHARACTERISTICS

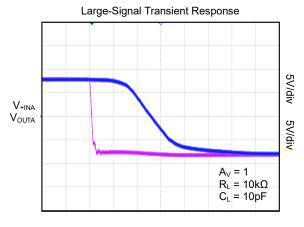
At $T_A = +25^{\circ}C$, $+V_S = 16V$, $-V_S = 0V$, unless otherwise specified.



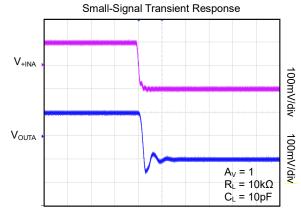
Time (50ns/div)



Time (50ns/div)



Time (50ns/div)



Time (50ns/div)



APPLICATION INFORMATION

The SGM8418-1/2/4 are specifically designed to drive high current load. These devices support rail-to-rail input and output operation, and consume low quiescent current. They can also provide a high slew rate. The combination of characteristics makes SGM8418-1/2/4 suitable for LCD applications.

Operating Voltage

The SGM8418-1/2/4 are guaranteed to operate from 4.5V to 26.5V, and the operation is extremely stable over the whole specified range of the temperature. The output voltage swing can be closer to the supply rail by reducing the load current.

LCD Panel Application

The SGM8418-1/2/4 can provide optimal performance in LCD V_{COM} buffer. They feature $\pm 3\text{A}$ transient peak source/sink current.

Output Current Limit

The SGM8418-1/2/4 can drive $\pm 3A$ transient peak output current. These devices have a $\pm 3A$ (TYP) current limit, which is accomplished with the characteristics of the internal metal interconnects. Maximum reliability is maintained if the output continuous current never exceeds ± 400 mA.

Thermal Consideration

When operating the devices, the users need to make sure that the junction temperature is below the absolute maximum one. The junction temperature is increasing because the power dissipation is higher than before. And a lot of possibilities can cause the thermal considerations, such as the width of trace in PCB, the package of the devices, the gap between ambient and junction temperature and rate of environmental airflow.

The following equation indicates the calculation of power dissipation:

$$P_{D(MAX)} = (T_{J(MAX)} - T_A)/\theta_{JA}$$
(1)

where:

 $T_{J(MAX)}$ = Maximum junction temperature.

 $T_A = Ambient temperature.$

 θ_{JA} = Junction to ambient thermal resistance.

It is recommended that the junction temperature should not exceed +125°C for normal operation. The parameter of ambient thermal resistance is determined by the width of trace in PCB layout.

In addition, the ambient temperature and thermal resistance will affect the power dissipation of SGM8418-1/2/4.

Layout

For the circuits with high power path, a good PCB design is essential. It is recommended to use the following layout method to improve the performance of SGM8418-1/2/4 at most.

• The power component should be close enough to SGM8418-1/2/4 for better performance. Also, if the high current is necessary, the corresponding trace in PCB should be short and wide.

• For some applications such as filtering, a series resistor is necessary to be added at the output of the devices.

• Choosing a suitable bypass capacitor can enhance the stability when driving the loads with high transient. For single-supply operation, the bypass capacitor should be placed as close to $+V_S$ pin as possible. For dual-supply operation, both $+V_S$ and $-V_S$ supplies should be bypassed to ground with separate 0.1μ F ceramic capacitors. Using a 10μ F tantalum capacitor is a good choice to improve the operating stability of the devices when driving high transient load.

• A 0.1μ F capacitor should be connected with +IN pin to GND for better operation of SGM8418-1/2/4 and the distance between this capacitor and +IN pin should be minimized.

 \bullet It is recommended to connect exposed pad to $\mathsf{-V}_\mathsf{S}$ directly in the PCB.



REVISION HISTORY

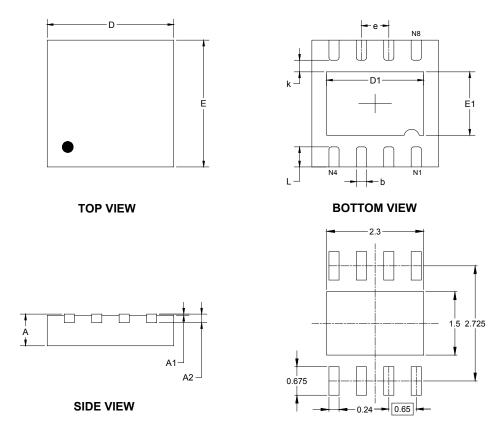
NOTE: Page numbers for previous revisions may differ from page numbers in the current version.

JULY 2020 – REV.A to REV.A.1	Page				
Updated TSSOP-14 (Exposed Pad) package					
pdated Tape and Reel Information section					
Changes from Original (MAY 2016) to REV.A	Page				
Changed from product preview to production data	All				



PACKAGE OUTLINE DIMENSIONS

TDFN-3×3-8L



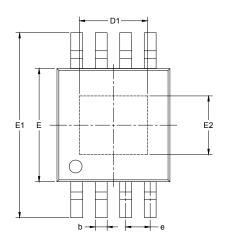
RECOMMENDED LAND PATTERN (Unit: mm)

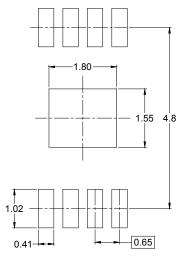
Symbol		nsions meters	Dimensions In Inches		
- ,	MIN	MAX	MIN	MAX	
A	0.700	0.800	0.028	0.031	
A1	0.000	0.050	0.000	0.002	
A2	0.203	B REF	0.008 REF		
D	2.900	3.100	0.114	0.122	
D1	2.200	2.400	0.087	0.094	
E	2.900	3.100	0.114	0.122	
E1	1.400	1.600	0.055	0.063	
k	0.200) MIN	0.008	3 MIN	
b	0.180	0.300	0.007	0.012	
е	0.650	0.650 TYP		TYP	
L	0.375	0.575	0.015	0.023	



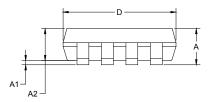
PACKAGE OUTLINE DIMENSIONS

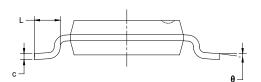
MSOP-8 (Exposed Pad)





RECOMMENDED LAND PATTERN (Unit: mm)



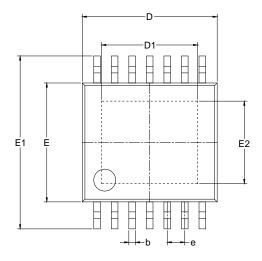


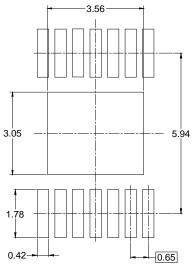
Symbol		nsions meters	-	nsions ches
- ,	MIN	MAX	MIN	MAX
A	0.820	1.100	0.032	0.043
A1	0.020	0.150	0.001	0.006
A2	0.750 0.950		0.030	0.037
b	0.250	0.380	0.010	0.015
С	0.090	0.230	0.004	0.009
D	2.900	3.100	0.114	0.122
D1	1.700	1.900	0.067	0.075
е	0.65	0.65 BSC		BSC
E	2.900	3.100	0.114	0.122
E1	4.750	5.050	0.187	0.199
E2	1.450	1.650	0.057	0.065
L	0.400	0.800	0.016	0.031
θ	0°	6°	0°	6°



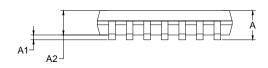
PACKAGE OUTLINE DIMENSIONS

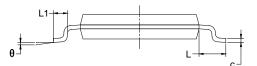
TSSOP-14 (Exposed Pad)





RECOMMENDED LAND PATTERN (Unit: mm)





Symbol	-	nsions meters	Dimensions In Inches		
	MIN	MAX	MIN	MAX	
A	1.200			0.047	
A1	0.050	0.150	0.002	0.006	
A2	0.800	1.050	0.031	0.041	
b	0.190	0.300	0.007	0.012	
с	0.090	0.200	0.004	0.008	
D	4.900	5.100	0.193	0.201	
D1	3.460	3.660	0.136	0.144	
E	4.300	4.500	0.169	0.177	
E1	6.250	6.550	0.246	0.258	
E2	2.950	3.150	0.116	0.124	
е	0.650 BSC		0.026	BSC	
L		1.000		0.039	
L1	0.450	0.750	0.018	0.030	
θ	0°	8°	0°	8°	



TAPE AND REEL INFORMATION

REEL DIMENSIONS



NOTE: The picture is only for reference. Please make the object as the standard.

Package Type	Reel Diameter	Reel Width W1 (mm)	A0 (mm)	B0 (mm)	K0 (mm)	P0 (mm)	P1 (mm)	P2 (mm)	W (mm)	Pin1 Quadrant
TDFN-3×3-8L	13″	12.4	3.35	3.35	1.13	4.0	8.0	2.0	12.0	Q1
MSOP-8 (Exposed Pad)	13″	12.4	5.20	3.30	1.50	4.0	8.0	2.0	12.0	Q1
TSSOP-14 (Exposed Pad)	13″	16.4	6.80	5.40	1.30	4.0	8.0	2.0	16.0	Q1

KEY PARAMETER LIST OF TAPE AND REEL

CARTON BOX DIMENSIONS



NOTE: The picture is only for reference. Please make the object as the standard.

KEY PARAMETER LIST OF CARTON BOX

Reel Type	Length (mm)	Width (mm)	Height (mm)	Pizza/Carton	
13″	386	280	370	5	DD0002

